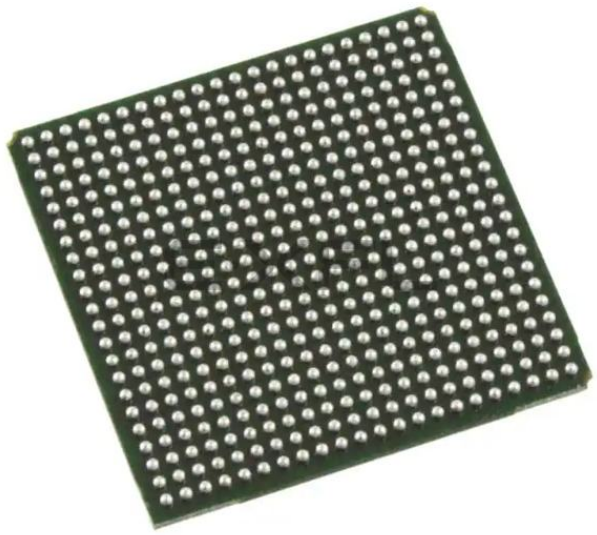
Lattice Semiconductor Corporation - LFE2-20SE-5F484I Datasheet



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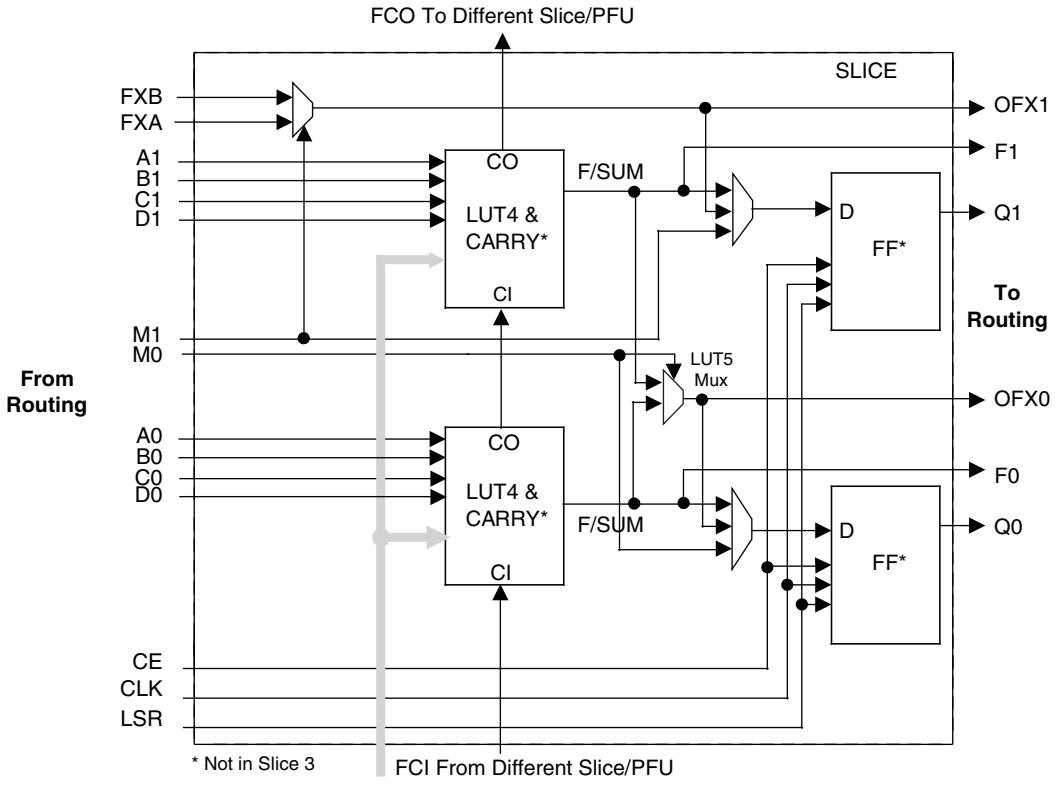
Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	2625
Number of Logic Elements/Cells	21000
Total RAM Bits	282624
Number of I/O	331
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-20se-5f484i

Figure 2-4. Slice Diagram



For Slices 0 and 2, memory control signals are generated from Slice 1 as follows:

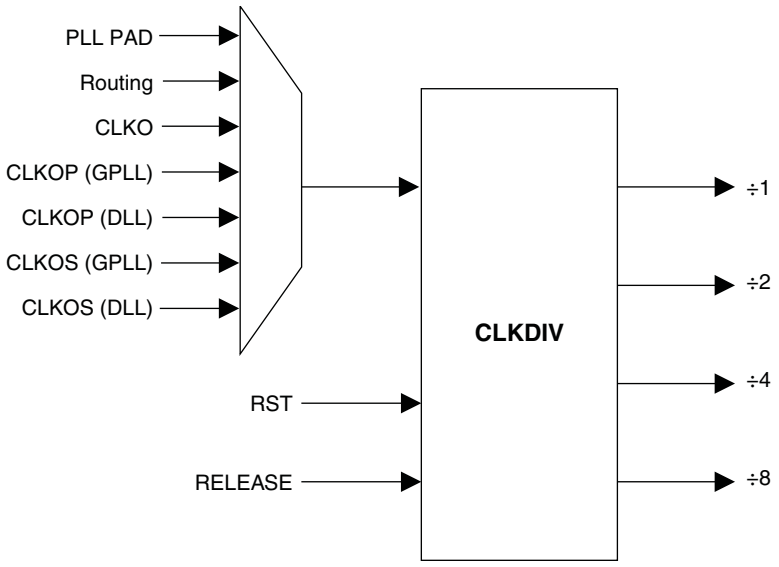
WCK is CLK
WRE is from LSR
DI[3:2] for Slice 2 and DI[1:0] for Slice 0 data
WAD [A:D] is a 4bit address from slice 1 LUT input

Table 2-2. Slice Signal Descriptions

Function	Type	Signal Names	Description
Input	Data signal	A0, B0, C0, D0	Inputs to LUT4
Input	Data signal	A1, B1, C1, D1	Inputs to LUT4
Input	Multi-purpose	M0	Multipurpose Input
Input	Multi-purpose	M1	Multipurpose Input
Input	Control signal	CE	Clock Enable
Input	Control signal	LSR	Local Set/Reset
Input	Control signal	CLK	System Clock
Input	Inter-PFU signal	FC	Fast Carry-in[1]
Input	Inter-slice signal	FXA	Intermediate signal to generate LUT6 and LUT7
Input	Inter-slice signal	FXB	Intermediate signal to generate LUT6 and LUT7
Output	Data signals	F0, F1	LUT4 output register bypass signals
Output	Data signals	Q0, Q1	Register outputs
Output	Data signals	OFX0	Output of a LUT5 MUX
Output	Data signals	OFX1	Output of a LUT6, LUT7, LUT8[2] MUX depending on the slice
Output	Inter-PFU signal	FCO	Slice 2 of each PFU is the fast carry chain output[1]

1. See Figure 2-4 for connection details.
2. Requires two PFUs.

Figure 2-9. Clock Divider Connections



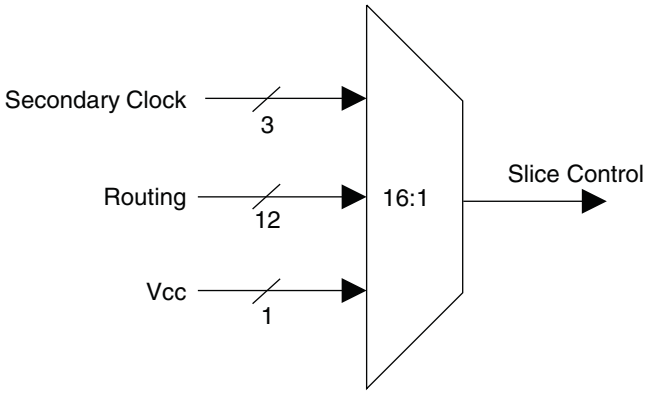
Clock Distribution Network

LatticeECP2/M devices have eight quadrant-based primary clocks and eight flexible region-based secondary clocks/control signals. Two high performance edge clocks are available on each edge of the device to support high speed interfaces. These clock inputs are selected from external I/Os, the sysCLOCK PLLs, DLLs or routing. These clock inputs are fed throughout the chip via a clock distribution system.

Primary Clock Sources

LatticeECP2/M devices derive clocks from five primary sources: PLL (GPLL and SPLL) outputs, DLL outputs, CLKDIV outputs, dedicated clock inputs and routing. LatticeECP2/M devices have two to eight sysCLOCK PLLs and two DLLs, located on the left and right sides of the device. There are eight dedicated clock inputs, two on each side of the device, with the exception of the LatticeECP2M 256-fpBGA package devices which have six dedicated clock inputs on the device. Figure 2-10 shows the primary clock sources.

Figure 2-18. Slice0 through Slice2 Control Selection



Edge Clock Routing

LatticeECP2/M devices have a number of high-speed edge clocks that are intended for use with the PIOs in the implementation of high-speed interfaces. There are eight edge clocks per device: two edge clocks per edge. Different PLL and DLL outputs are routed to the two muxes on the left and right sides of the device. In addition, the CLKO signal (generated from the DLLDELA block) is routed to all the edge clock muxes on the left and right sides of the device. Figure 2-19 shows the selection muxes for these clocks.

Figure 2-19. Edge Clock Mux Connections

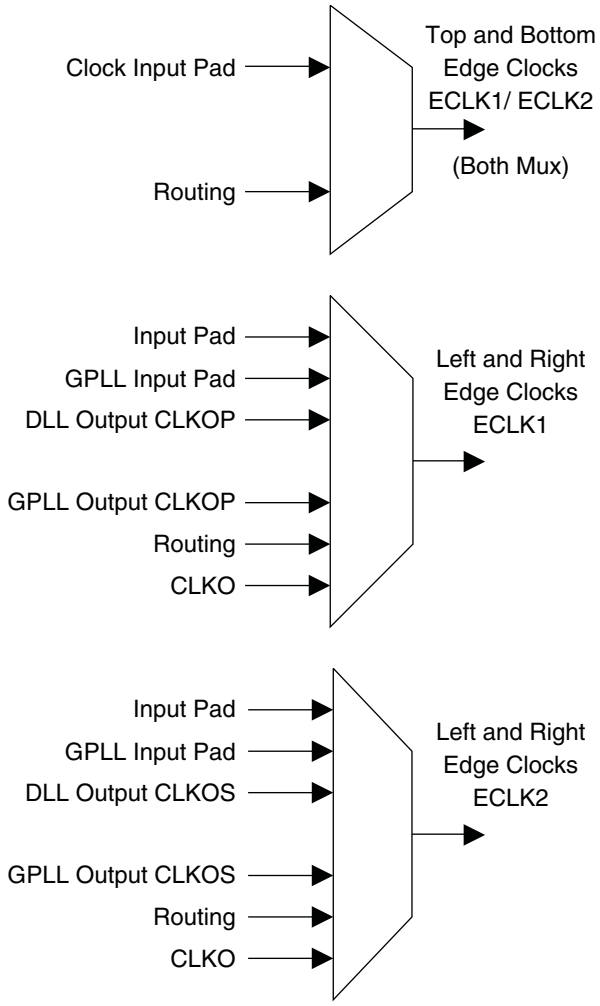
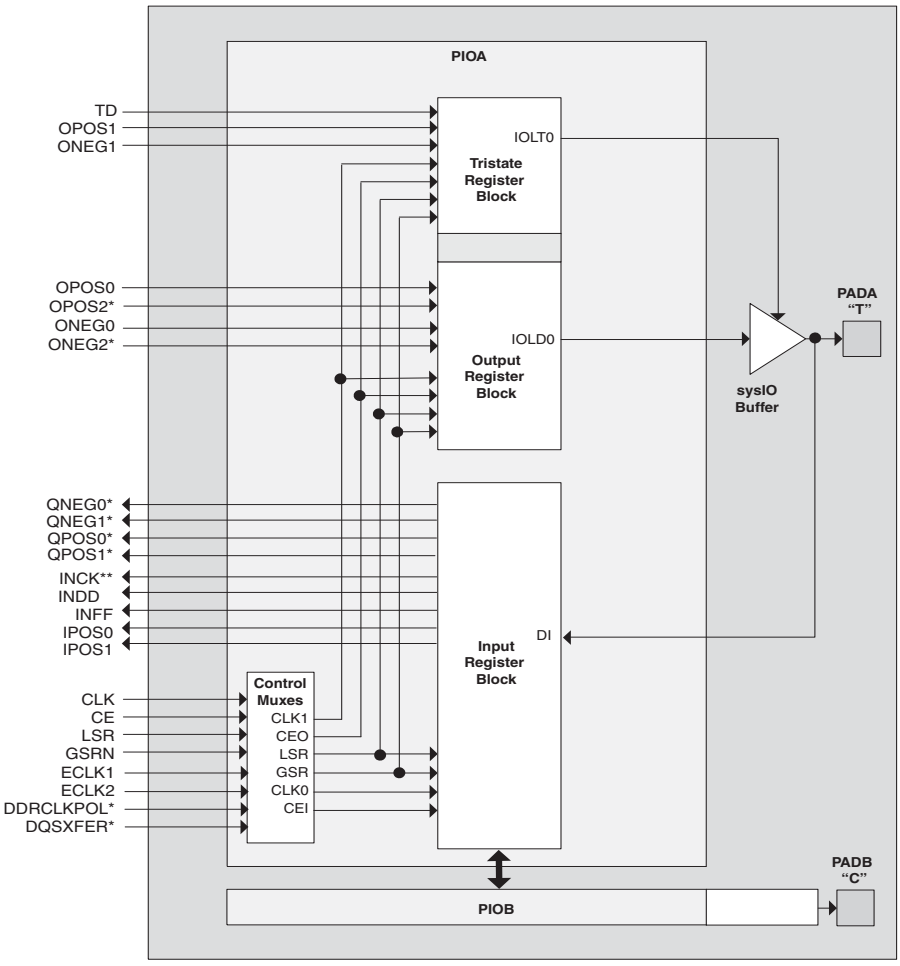


Figure 2-28. PIC Diagram



*Signals are available on left/right/bottom edges only.
** Selected blocks.

Two adjacent PIOs can be joined to provide a differential I/O pair (labeled as “T” and “C”) as shown in Figure 2-28. The PAD Labels “T” and “C” distinguish the two PIOs. Approximately 50% of the PIO pairs on the left and right edges of the device can be configured as true LVDS outputs. All I/O pairs can operate as inputs.

DC Electrical Characteristics

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{IL}, I_{IH}[1, 2]	Input or I/O Low Leakage	$0 \le V_{IN} \le (V_{CCIO} - 0.2V)$	—	—	10	µA
I_{IH}[1, 3]	Input or I/O High Leakage	$(V_{CCIO} - 0.2V) < V_{IN} \le 3.6V$	—	—	150	µA
I_{PU}	I/O Active Pull-up Current	$0 \le V_{IN} \le 0.7\ V_{CCIO}$	-30	—	-210	µA
I_{PD}	I/O Active Pull-down Current	V_{IL} (MAX) $\le V_{IN} \le V_{IH}$ (MAX)	30	—	210	µA
I_{BHLS}	Bus Hold Low Sustaining Current	$V_{IN} = V_{IL}$ (MAX)	30	—	—	µA
I_{BHHS}	Bus Hold High Sustaining Current	$V_{IN} = 0.7\ V_{CCIO}$	-30	—	—	µA
I_{BHLO}	Bus Hold Low Overdrive Current	$0 \le V_{IN} \le V_{CCIO}$	—	—	210	µA
I_{BHHO}	Bus Hold High Overdrive Current	$0 \le V_{IN} \le V_{CCIO}$	—	—	-210	µA
V_{BHT}	Bus Hold Trip Points	$0 \le V_{IN} \le V_{IH}$ (MAX)	V_{IL} (MAX)	—	V_{IH} (MIN)	V
C1[4]	I/O Capacitance	V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V, V_{CC} = 1.2V, V_{IO} = 0 to V_{IH} (MAX)	—	5	8	pf
C2[4]	Dedicated Input Capacitance	V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V, V_{CC} = 1.2V, V_{IO} = 0 to V_{IH} (MAX)	—	5	6	pf

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.
2. When used as V_{REF}, maximum leakage = 25uA
3. Applicable to general purpose I/Os in top and bottom banks.
4. T_A 25°C, f = 1.0MHz.

sysI/O Single-Ended DC Electrical Characteristics

Input/Output Standard	V_{IL}		V_{IH}		V_{OL} Max. (V)	V_{OH} Min. (V)	I_{OL}[1] (mA)	I_{OH}[1] (mA)
	Min. (V)	Max. (V)	Min. (V)	Max. (V)				
LVCMOS 3.3	-0.3	0.8	2.0	3.6	0.4	V_{CCIO} - 0.4	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	V_{CCIO} - 0.2	0.1	-0.1
LVTTL	-0.3	0.8	2.0	3.6	0.4	V_{CCIO} - 0.4	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	V_{CCIO} - 0.2	0.1	-0.1
LVCMOS 2.5	-0.3	0.7	1.7	3.6	0.4	V_{CCIO} - 0.4	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	V_{CCIO} - 0.2	0.1	-0.1
LVCMOS 1.8	-0.3	0.35 V_{CCIO}	0.65 V_{CCIO}	3.6	0.4	V_{CCIO} - 0.4	16, 12, 8, 4	-16, -12, -8, -4
					0.2	V_{CCIO} - 0.2	0.1	-0.1
LVCMOS 1.5	-0.3	0.35 V_{CCIO}	0.65 V_{CCIO}	3.6	0.4	V_{CCIO} - 0.4	8, 4	-8, -4
					0.2	V_{CCIO} - 0.2	0.1	-0.1
LVCMOS 1.2	-0.3	0.35 V_{CC}	0.65 V_{CC}	3.6	0.4	V_{CCIO} - 0.4	6, 2	-6, -2
					0.2	V_{CCIO} - 0.2	0.1	-0.1
PCI	-0.3	0.3 V_{CCIO}	0.5 V_{CCIO}	3.6	0.1 V_{CCIO}	0.9 V_{CCIO}	1.5	-0.5
SSTL3 Class I	-0.3	V_{REF} - 0.2	V_{REF} + 0.2	3.6	0.7	V_{CCIO} - 1.1	8	-8
SSTL3 Class II	-0.3	V_{REF} - 0.2	V_{REF} + 0.2	3.6	0.5	V_{CCIO} - 0.9	16	-16
SSTL2 Class I	-0.3	V_{REF} - 0.18	V_{REF} + 0.18	3.6	0.54	V_{CCIO} - 0.62	7.6	-7.6
							12	-12
SSTL2 Class II	-0.3	V_{REF} - 0.18	V_{REF} + 0.18	3.6	0.35	V_{CCIO} - 0.43	15.2	-15.2
							20	-20
SSTL18 Class I	-0.3	V_{REF} - 0.125	V_{REF} + 0.125	3.6	0.4	V_{CCIO} - 0.4	6.7	-6.7
SSTL18 Class II	-0.3	V_{REF} - 0.125	V_{REF} + 0.125	3.6	0.28	V_{CCIO} - 0.28	8	-8
							11	-11
HSTL Class I	-0.3	V_{REF} - 0.1	V_{REF} + 0.1	3.6	0.4	V_{CCIO} - 0.4	4	-4
							8	-8
HSTL18 Class I	-0.3	V_{REF} - 0.1	V_{REF} + 0.1	3.6	0.4	V_{CCIO} - 0.4	8	-8
							12	-12
HSTL18 Class II	-0.3	V_{REF} - 0.1	V_{REF} + 0.1	3.6	0.4	V_{CCIO} - 0.4	16	-16

1. The average DC current drawn by I/Os between GND connections, or between the last GND in an I/O bank and the end of an I/O bank, as shown in the logic signal connections table shall not exceed n * 8mA, where n is the number of I/Os between bank GND connections or between the last GND in a bank and the end of a bank.

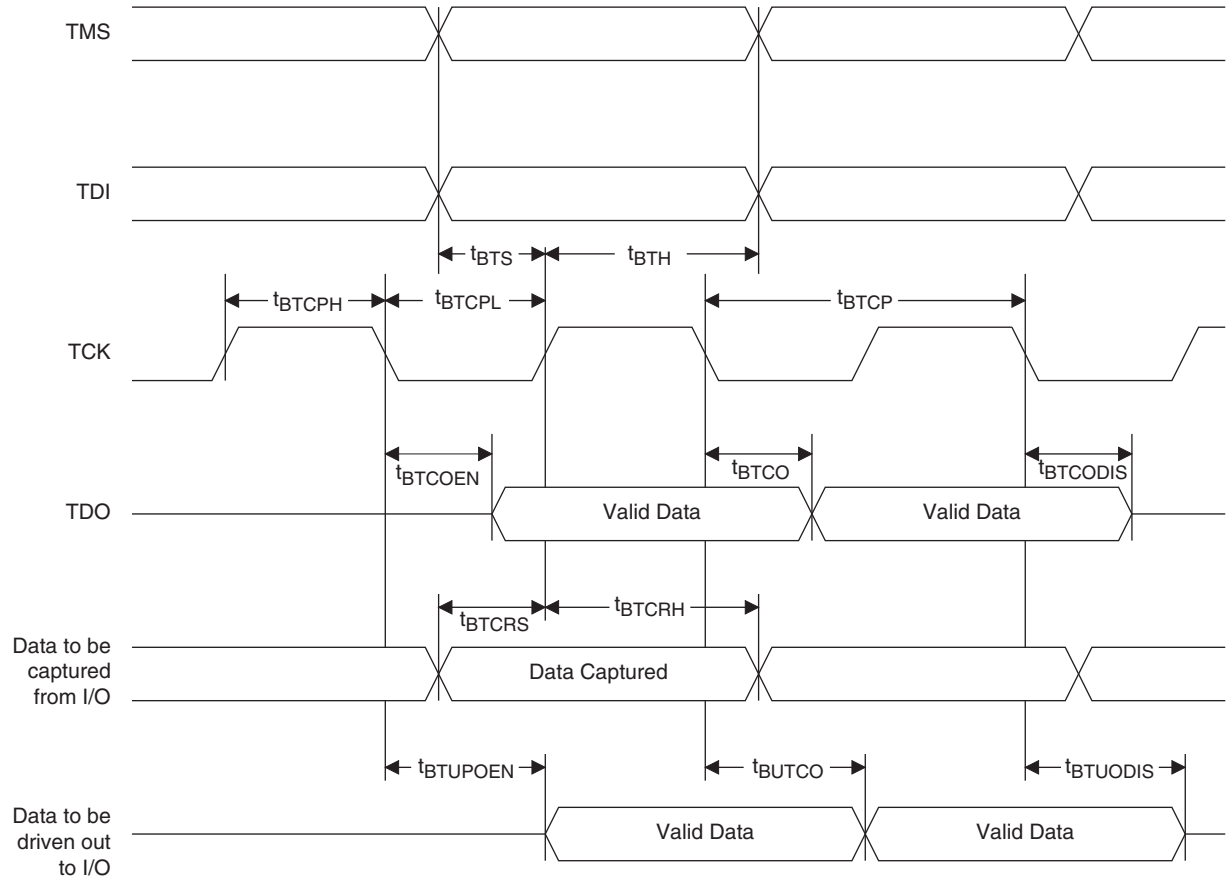
JTAG Port Timing Specifications

Over Recommended Operating Conditions

Symbol	Parameter	Min	Max	Units
f_{MAX}	TCK clock frequency	—	25	MHz
t_{BTCP}	TCK [BSCAN] clock pulse width	40	—	ns
t_{BTCPH}	TCK [BSCAN] clock pulse width high	20	—	ns
t_{BTCPL}	TCK [BSCAN] clock pulse width low	20	—	ns
t_{BTS}	TCK [BSCAN] setup time	8	—	ns
t_{BTH}	TCK [BSCAN] hold time	10	—	ns
t_{BTRF}	TCK [BSCAN] rise/fall time	50	—	mV/ns
t_{BTCO}	TAP controller falling edge of clock to valid output	—	10	ns
$t_{BTCODIS}$	TAP controller falling edge of clock to valid disable	—	10	ns
t_{BTCOEN}	TAP controller falling edge of clock to valid enable	—	10	ns
t_{BTCRS}	BSCAN test capture register setup time	8	—	ns
t_{BTCRH}	BSCAN test capture register hold time	25	—	ns
t_{BUTCO}	BSCAN test update register, falling edge of clock to valid output	—	25	ns
$t_{BTUODIS}$	BSCAN test update register, falling edge of clock to valid disable	—	25	ns
$t_{BTUPOEN}$	BSCAN test update register, falling edge of clock to valid enable	—	25	ns

Timing v.A 0.11

Figure 3-21. JTAG Port Timing Waveforms



LatticeECP2M Pin Information Summary, LFE2M20 and LFE2M35

Pin Type		LFE2M20		LFE2M35		
		256 fpBGA	484 fpBGA	256 fpBGA	484 fpBGA	672 fpBGA
Single Ended User I/O		140	304	140	303	410
Differential Pair User I/O		70	152	70	151	199
Configuration	TAP Pins	5	5	5	5	5
	Muxed Pins	14	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7	7
Non Configuration	Muxed Pins	64	84	60	84	89
	Dedicated Pins	3	3	3	3	3
VCC		6	16	6	16	29
VCCAUX		4	8	4	8	17
VCCPLL		1	4	1	4	8
VCCIO	Bank0	1	4	1	4	5
	Bank1	1	3	1	3	4
	Bank2	2	4	2	4	5
	Bank3	2	4	2	4	5
	Bank4	2	4	2	4	4
	Bank5	2	4	2	4	5
	Bank6	2	4	2	4	5
	Bank7	2	4	2	4	5
	Bank8	1	2	1	2	2
GND, GND0 to GND7		22	57	22	57	80
NC		17	11	17	12	37
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	0/0	36/18	0/0	36/18	63/31
	Bank1	0/0	18/9	0/0	18/9	18/9
	Bank2	14/7	30/15	14/7	30/15	50/25
	Bank3	16/8	36/18	16/8	36/18	43/21
	Bank4	32/16	62/31	32/16	62/31	50/21
	Bank5	20/10	28/14	20/10	28/14	60/30
	Bank6	16/8	40/20	16/8	39/19	52/25
	Bank7	28/14	40/20	28/14	40/20	60/30
	Bank8	14/7	14/7	14/7	14/7	14/7
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0	0
	Bank2 (Right Edge)	3	7	3	7	12
	Bank3 (Right Edge)	4	9	4	9	11
	Bank4 (Bottom Edge)	0	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0	0
	Bank6 (Left Edge)	4	10	4	10	14
	Bank7 (Left Edge)	7	10	7	10	15
	Bank8 (Right Edge)	0	0	0	0	0

LFE2-20E/SE Logic Signal Connections: 256 fpBGA

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
C3	C3	PL2A	7	VREF2_7	T (LVDS)*
C2	C2	PL2B	7	VREF1_7	C (LVDS)*
VCCIO	VCCIO	VCCIO7	7		
-	GND	GNDIO7	7		
D3	D3	PL7A	7	LDQ8	T
D4	D4	PL6A	7	LDQ8	T (LVDS)*
D2	D2	PL7B	7	LDQ8	C
GND	GND	GNDIO7	-		
E4	E4	PL6B	7	LDQ8	C (LVDS)*
B1	B1	PL13A	7	LDQ16	T
C1	C1	PL13B	7	LDQ16	C
F5	F5	PL15A	7	LDQ16	T
VCCIO	VCC	VCCIO	7		
F4	F4	PL14A	7	LDQ16	T (LVDS)*
G6	G6	PL15B	7	LDQ16	C
G4	G4	PL14B	7	LDQ16	C (LVDS)*
D1	D1	PL16A	7	LDQS16	T (LVDS)*
GND	GND	GNDIO7	-		
E1	E1	PL16B	7	LDQ16	C (LVDS)*
F3	F3	PL17A	7	LDQ16	T
G3	G3	PL17B	7	LDQ16	C
VCCIO	VCCIO	VCCIO7	7		
F2	F2	PL18A	7	LDQ16	T (LVDS)*
F1	F1	PL18B	7	LDQ16	C (LVDS)*
GND	GND	GNDIO7	-		
G2	G2	PL19A	7	PCLKT7_0/LDQ16	T
G1	G1	PL19B	7	PCLKC7_0/LDQ16	C
H6	H6	PL21A	6	PCLKT6_0/LDQ25	T (LVDS)*
VCCIO	VCCIO	VCCIO6	6		
H5	H5	PL21B	6	PCLKC6_0/LDQ25	C (LVDS)*
H4	H4	PL22A	6	VREF2_6/LDQ25	T
GND	GND	GNDIO6	-		
H3	H3	PL22B	6	VREF1_6/LDQ25	C
H2	H2	PL27A	6	LLM0_GDLLT_IN_A**/LDQ25	T (LVDS)*
H1	H1	PL27B	6	LLM0_GDLLC_IN_A**/LDQ25	C (LVDS)*
G10	G10	VCC	-		
J4	J4	PL28A	6	LLM0_GDLLT_FB_A/LDQ25	T
J5	J5	PL28B	6	LLM0_GDLLC_FB_A/LDQ25	C
J6	J6	LLM0_PLLCAP	6		
K4	K4	PL30A	6	LLM0_GPLLT_IN_A**/LDQ34	T (LVDS)*
GND	GND	GNDIO6	-		

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
P5	P5	VCCIO5	5		
K5	K5	VCCIO6	6		
M3	M3	VCCIO6	6		
E3	E3	VCCIO7	7		
G5	G5	VCCIO7	7		
T15	T15	VCCIO8	8		
A1	A1	GND	-		
A16	A16	GND	-		
B12	B12	GND	-		
B5	B5	GND	-		
C8	C8	GND	-		
E15	E15	GND	-		
E2	E2	GND	-		
H14	H14	GND	-		
H8	H8	GND	-		
H9	H9	GND	-		
J3	J3	GND	-		
J8	J8	GND	-		
J9	J9	GND	-		
M15	M15	GND	-		
M2	M2	GND	-		
P9	P9	GND	-		
R12	R12	GND	-		
R5	R5	GND	-		
T1	T1	GND	-		
T16	T16	GND	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.
** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
M19	NC	-			PR26A	3	RDQ25	T
J22	NC	-			PR23B	3	RDQ25	C (LVDS)*
-	-	-			GNDIO	-		
L22	NC	-			PR24B	3	RDQ25	C
H22	NC	-			PR23A	3	RDQ25	T (LVDS)*
K22	NC	-			PR24A	3	RDQ25	T
M20	PR16B	3	VREF2_3	C	PR22B	3	VREF2_3/RDQ25	C
VCCIO	VCCIO3	3			VCCIO3	3		
L21	PR16A	3	VREF1_3	T	PR22A	3	VREF1_3/RDQ25	T
K21	PR15B	3	PCLKC3_0	C (LVDS)*	PR21B	3	PCLKC3_0/RDQ25	C (LVDS)*
J21	PR15A	3	PCLKT3_0	T (LVDS)*	PR21A	3	PCLKT3_0/RDQ25	T (LVDS)*
M18	PR13B	2	PCLKC2_0/RDQ10	C	PR19B	2	PCLKC2_0/RDQ16	C
GNDIO	GNDIO2	-			GNDIO2	-		
L17	PR13A	2	PCLKT2_0/RDQ10	T	PR19A	2	PCLKT2_0/RDQ16	T
L19	PR12B	2	RDQ10	C (LVDS)*	PR18B	2	RDQ16	C (LVDS)*
K18	PR10B	2	RDQ10	C (LVDS)*	PR16B	2	RDQ16	C (LVDS)*
L20	PR12A	2	RDQ10	T (LVDS)*	PR18A	2	RDQ16	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO2	2		
K19	PR10A	2	RDQS10	T (LVDS)*	PR16A	2	RDQS16	T (LVDS)*
L18	PR11B	2	RDQ10	C	PR17B	2	RDQ16	C
K17	PR11A	2	RDQ10	T	PR17A	2	RDQ16	T
GNDIO	GNDIO2	-			GNDIO2	-		
J17	PR8B	2	RDQ10	C (LVDS)*	PR14B	2	RDQ16	C (LVDS)*
G22	PR9B	2	RDQ10	C	PR15B	2	RDQ16	C
J18	PR8A	2	RDQ10	T (LVDS)*	PR14A	2	RDQ16	T (LVDS)*
F22	PR9A	2	RDQ10	T	PR15A	2	RDQ16	T
VCCIO	VCCIO2	2			VCCIO2	2		
H21	PR6B	2	RDQ10	C (LVDS)*	PR12B	2	RDQ16	C (LVDS)*
K20	PR7B	2	RDQ10	C	PR13B	2	RDQ16	C
G21	PR6A	2	RDQ10	T (LVDS)*	PR12A	2	RDQ16	T (LVDS)*
J19	PR7A	2	RDQ10	T	PR13A	2	RDQ16	T
D22	NC	-			PR10B	2	RDQ8	C (LVDS)*
F21	NC	-			PR11B	2	RDQ8	C
-	-	-			GNDIO	-		
E21	NC	-			PR10A	2	RDQ8	T (LVDS)*
E22	NC	-			PR11A	2	RDQ8	T
H19	NC	-			PR8B	2	RDQ8	C (LVDS)*
G20	NC	-			PR9B	2	RDQ8	C
-	-	-			VCCIO2	2		
G19	NC	-			PR8A	2	RDQS8	T (LVDS)*
F20	NC	-			PR9A	2	RDQ8	T
G17	PR5B	2		C	PR7B	2	RDQ8	C
GNDIO	GNDIO2	-			GNDIO2	-		
E20	PR4B	2		C (LVDS)*	PR6B	2	RDQ8	C (LVDS)*

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N15	GND	-			GND	-		
N17	GND	-			GND	-		
P10	GND	-			GND	-		
P12	GND	-			GND	-		
P13	GND	-			GND	-		
P14	GND	-			GND	-		
P15	GND	-			GND	-		
P17	GND	-			GND	-		
R13	GND	-			GND	-		
R14	GND	-			GND	-		
T10	GND	-			GND	-		
T11	GND	-			GND	-		
T16	GND	-			GND	-		
T17	GND	-			GND	-		
T24	GND	-			GND	-		
T3	GND	-			GND	-		
U10	GND	-			GND	-		
U11	GND	-			GND	-		
U13	GND	-			GND	-		
U14	GND	-			GND	-		
U16	GND	-			GND	-		
U17	GND	-			GND	-		
V13	GND	-			GND	-		
V14	GND	-			GND	-		
V21	GND	-			GND	-		
V6	GND	-			GND	-		
M3	NC	-			NC	-		
N6	NC	-			NC	-		
P24	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.
** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.
***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
AB24	PR87B	8	D3	C
GND	GNDIO4	-		
AB23	PR87A	8	D4	T
AB25	PR86B	8	D5	C
AB26	PR86A	8	D6	T
AC27	PR85B	8	D7/SPID0	C
VCCIO	VCCIO8	8		
AB27	PR85A	8	DI/CSSPI0N	T
AD29	PR84B	8	DOUT/CSON	C
AD30	PR84A	8	BUSY/SISPI	T
AA25	PR83B	3	RDQ80	C
GND	GNDIO3	-		
AA23	PR83A	3	RDQ80	T
AC29	PR82B	3	RDQ80	C (LVDS)*
AC30	PR82A	3	RDQ80	T (LVDS)*
AA26	PR81B	3	RDQ80	C
VCCIO	VCCIO3	3		
AA24	PR81A	3	RDQ80	T
AB29	PR80B	3	RDQ80	C (LVDS)*
AB30	PR80A	3	RDQS80	T (LVDS)*
GND	GNDIO3	-		
Y23	PR79B	3	RDQ80	C
Y25	PR79A	3	RDQ80	T
AA27	PR78B	3	RDQ80	C (LVDS)*
AA28	PR78A	3	RDQ80	T (LVDS)*
VCCIO	VCCIO3	3		
Y24	PR77B	3	RLM0_GPLLC_FB_A/RDQ80	C
Y26	PR77A	3	RLM0_GPLLT_FB_A/RDQ80	T
AA29	PR76B	3	RLM0_GPLLC_IN_A**/RDQ80	C (LVDS)*
AA30	PR76A	3	RLM0_GPLLT_IN_A**/RDQ80	T (LVDS)*
R22	RLM0_PLLCAP	3		
W23	PR74B	3	RLM0_GDLLC_FB_A/RDQ71	C
W25	PR74A	3	RLM0_GDLLT_FB_A/RDQ71	T
GND	GNDIO3	-		
Y27	PR73B	3	RLM0_GDLLC_IN_A**/RDQ71	C (LVDS)*
Y28	PR73A	3	RLM0_GDLLT_IN_A**/RDQ71	T (LVDS)*
W24	PR72B	3	RDQ71	C
W26	PR72A	3	RDQ71	T
VCCIO	VCCIO3	3		
Y29	PR71B	3	RDQ71	C (LVDS)*
Y30	PR71A	3	RDQS71	T (LVDS)*
V25	PR70B	3	RDQ71	C
GND	GNDIO3	-		

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AJ17	PB62B	4	BDQ60	C	PB71B	4	BDQ69	C
VCCIO	VCCIO4	4			VCCIO4	4		
AF26	PB64A	4	BDQ60	T	PB73A	4	BDQ69	T
AE25	PB64B	4	BDQ60	C	PB73B	4	BDQ69	C
GNDIO	GNDIO4	-			GNDIO4	-		
AD24	PB65A	4	BDQ69	T	PB74A	4	BDQ78	T
AE24	PB65B	4	BDQ69	C	PB74B	4	BDQ78	C
AD18	PB66A	4	BDQ69	T	PB75A	4	BDQ78	T
AC18	PB66B	4	BDQ69	C	PB75B	4	BDQ78	C
AE18	PB67A	4	BDQ69	T	PB76A	4	BDQ78	T
AG19	PB67B	4	BDQ69	C	PB76B	4	BDQ78	C
VCCIO	VCCIO4	4			VCCIO4	4		
GNDIO	GNDIO4	-			GNDIO4	-		
AC19	PB69A	4	BDQS69	T	PB78A	4	BDQS78	T
AD20	PB69B	4	BDQ69	C	PB78B	4	BDQ78	C
AB18	PB70A	4	BDQ69	T	PB79A	4	BDQ78	T
AC20	PB70B	4	BDQ69	C	PB79B	4	BDQ78	C
AE20	PB71A	4	BDQ69	T	PB80A	4	BDQ78	T
AE21	PB71B	4	BDQ69	C	PB80B	4	BDQ78	C
VCCIO	VCCIO4	4			VCCIO4	4		
AC23	PB72A	4	BDQ69	T	PB81A	4	BDQ78	T
AD23	PB72B	4	BDQ69	C	PB81B	4	BDQ78	C
GNDIO	GNDIO4	-			GNDIO4	-		
AH18	LRC_SQ_VCCRX3	13			LRC_SQ_VCCRX3	13		
AK19	LRC_SQ_HDINP3	13		T	LRC_SQ_HDINP3	13		T
AJ18	LRC_SQ_VCCIB3	13			LRC_SQ_VCCIB3	13		
AJ19	LRC_SQ_HDINN3	13		C	LRC_SQ_HDINN3	13		C
AH21	LRC_SQ_VCCTX3	13			LRC_SQ_VCCTX3	13		
AK22	LRC_SQ_HDOUTP3	13		T	LRC_SQ_HDOUTP3	13		T
AK21	LRC_SQ_VCCOB3	13			LRC_SQ_VCCOB3	13		
AJ22	LRC_SQ_HDOUTN3	13		C	LRC_SQ_HDOUTN3	13		C
AH22	LRC_SQ_VCCTX2	13			LRC_SQ_VCCTX2	13		
AJ23	LRC_SQ_HDOUTN2	13		C	LRC_SQ_HDOUTN2	13		C
AH23	LRC_SQ_VCCOB2	13			LRC_SQ_VCCOB2	13		
AK23	LRC_SQ_HDOUTP2	13		T	LRC_SQ_HDOUTP2	13		T
AH19	LRC_SQ_VCCRX2	13			LRC_SQ_VCCRX2	13		
AJ20	LRC_SQ_HDINN2	13		C	LRC_SQ_HDINN2	13		C
AH20	LRC_SQ_VCCIB2	13			LRC_SQ_VCCIB2	13		
AK20	LRC_SQ_HDINP2	13		T	LRC_SQ_HDINP2	13		T
AH24	LRC_SQ_VCCP	13			LRC_SQ_VCCP	13		
AG24	LRC_SQ_REFCLKP	13		T	LRC_SQ_REFCLKP	13		T
AF24	LRC_SQ_REFCLKN	13		C	LRC_SQ_REFCLKN	13		C
AJ24	LRC_SQ_VCCAUX33	13			LRC_SQ_VCCAUX33	13		
AK28	LRC_SQ_HDINP1	13		T	LRC_SQ_HDINP1	13		T
AH28	LRC_SQ_VCCIB1	13			LRC_SQ_VCCIB1	13		
AJ28	LRC_SQ_HDINN1	13		C	LRC_SQ_HDINN1	13		C
AH29	LRC_SQ_VCCRX1	13			LRC_SQ_VCCRX1	13		
AK25	LRC_SQ_HDOUTP1	13		T	LRC_SQ_HDOUTP1	13		T

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AH25	LRC_SQ_VCCOB1	13			LRC_SQ_VCCOB1	13		
AJ25	LRC_SQ_HDOUTN1	13		C	LRC_SQ_HDOUTN1	13		C
AH26	LRC_SQ_VCCTX1	13			LRC_SQ_VCCTX1	13		
AJ26	LRC_SQ_HDOUTN0	13		C	LRC_SQ_HDOUTN0	13		C
AK27	LRC_SQ_VCCOB0	13			LRC_SQ_VCCOB0	13		
AK26	LRC_SQ_HDOUTP0	13		T	LRC_SQ_HDOUTP0	13		T
AH27	LRC_SQ_VCCTX0	13			LRC_SQ_VCCTX0	13		
AJ29	LRC_SQ_HDINN0	13		C	LRC_SQ_HDINN0	13		C
AJ30	LRC_SQ_VCCIB0	13			LRC_SQ_VCCIB0	13		
AK29	LRC_SQ_HDINP0	13		T	LRC_SQ_HDINP0	13		T
AH30	LRC_SQ_VCCRX0	13			LRC_SQ_VCCRX0	13		
AG27	CFG2	8			CFG2	8		
AD25	CFG1	8			CFG1	8		
AG28	CFG0	8			CFG0	8		
AG30	PROGRAMN	8			PROGRAMN	8		
AG29	CCLK	8			CCLK	8		
AC24	INITN	8			INITN	8		
AF27	DONE	8			DONE	8		
GNDIO	GNDIO8	-			GNDIO8	-		
AF28	WRITEN***	8			WRITEN***	8		
AE26	CS1N***	8			CS1N***	8		
AB23	CSN***	8			CSN***	8		
AF29	D0/SPIFASTN***	8			D0/SPIFASTN***	8		
VCCIO	VCCIO8	8			VCCIO8	8		
AF30	D1***	8			D1***	8		
AD26	D2***	8			D2***	8		
AE29	D3***	8			D3***	8		
GNDIO	GNDIO8	-			GNDIO8	-		
AE30	D4***	8			D4***	8		
AD29	D5***	8			D5***	8		
AC25	D6***	8			D6***	8		
AD30	D7/SPID0***	8			D7/SPID0***	8		
VCCIO	VCCIO8	8			VCCIO8	8		
AA22	DI/CSSPI0N***	8			DI/CSSPI0N***	8		
AC26	DOUT/CSON/ CSSPI1N***	8			DOUT/CSON/ CSSPI1N***	8		
AA23	BUSY/SISPI***	8			BUSY/SISPI***	8		
AB22	RLM0_PLLCAP	3			RLM0_PLLCAP	3		
AC27	PR65B	3	RLM0_GDLLC_FB_A	C	PR85B	3	RLM0_GDLLC_FB_A/RDQ82	C
GNDIO	GNDIO3	-			GNDIO3	-		
AC28	PR65A	3	RLM0_GDLLT_FB_A	T	PR85A	3	RLM0_GDLLT_FB_A/RDQ82	T
AC29	PR64B	3	RLM0_GDLLC_IN_A**	C (LVDS)*	PR84B	3	RLM0_GDLLC_IN_A**/RDQ82	C (LVDS)*
AC30	PR64A	3	RLM0_GDLLT_IN_A**	T (LVDS)*	PR84A	3	RLM0_GDLLT_IN_A**/RDQ82	T (LVDS)*
AB30	PR63B	3	RLM0_GPLLC_IN_A**	C	PR83B	3	RLM0_GPLLC_IN_A**/RDQ82	C
VCCIO	VCCIO3	3			VCCIO3	3		
AA30	PR63A	3	RLM0_GPLLT_IN_A**	T	PR83A	3	RLM0_GPLLT_IN_A**/RDQ82	T
AB29	PR62B	3	RLM0_GPLLC_FB_A	C (LVDS)*	PR82B	3	RLM0_GPLLC_FB_A/RDQ82	C (LVDS)*
AB28	PR62A	3	RLM0_GPLLT_FB_A	T (LVDS)*	PR82A	3	RLM0_GPLLT_FB_A/RDQS82	T (LVDS)*
GNDIO	GNDIO3	-			GNDIO3	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
K19	VCCIO1	1		
F28	VCCIO2	2		
J25	VCCIO2	2		
K28	VCCIO2	2		
M21	VCCIO2	2		
M24	VCCIO2	2		
N21	VCCIO2	2		
N28	VCCIO2	2		
P21	VCCIO2	2		
R25	VCCIO2	2		
AA28	VCCIO3	3		
AB25	VCCIO3	3		
AE28	VCCIO3	3		
T25	VCCIO3	3		
U21	VCCIO3	3		
V21	VCCIO3	3		
V28	VCCIO3	3		
W21	VCCIO3	3		
W24	VCCIO3	3		
AA18	VCCIO4	4		
AA19	VCCIO4	4		
AE19	VCCIO4	4		
AF22	VCCIO4	4		
AG17	VCCIO4	4		
AG25	VCCIO4	4		
AA12	VCCIO5	5		
AA13	VCCIO5	5		
AE12	VCCIO5	5		
AF9	VCCIO5	5		
AG14	VCCIO5	5		
AG6	VCCIO5	5		
AA3	VCCIO6	6		
AB6	VCCIO6	6		
AE3	VCCIO6	6		
T6	VCCIO6	6		
U10	VCCIO6	6		
V10	VCCIO6	6		
V3	VCCIO6	6		
W10	VCCIO6	6		
W7	VCCIO6	6		
F3	VCCIO7	7		
J6	VCCIO7	7		
K3	VCCIO7	7		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
M10	VCCIO7	7		
M7	VCCIO7	7		
N10	VCCIO7	7		
N3	VCCIO7	7		
P10	VCCIO7	7		
R6	VCCIO7	7		
AA25	VCCIO8	8		
AD28	VCCIO8	8		
AA10	VCCAUX	-		
AA11	VCCAUX	-		
AA20	VCCAUX	-		
AA21	VCCAUX	-		
K10	VCCAUX	-		
K11	VCCAUX	-		
K20	VCCAUX	-		
K21	VCCAUX	-		
L10	VCCAUX	-		
L11	VCCAUX	-		
L20	VCCAUX	-		
L21	VCCAUX	-		
Y10	VCCAUX	-		
Y11	VCCAUX	-		
Y20	VCCAUX	-		
Y21	VCCAUX	-		
A1	GND	-		
A13	GND	-		
A18	GND	-		
A24	GND	-		
A30	GND	-		
A7	GND	-		
AA14	GND	-		
AA15	GND	-		
AA16	GND	-		
AA17	GND	-		
AA24	GND	-		
AA27	GND	-		
AA4	GND	-		
AB24	GND	-		
AB7	GND	-		
AD12	GND	-		
AD19	GND	-		
AD27	GND	-		
AE22	GND	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
AE23	NC	-		
AE5	NC	-		
AE6	NC	-		
AE7	NC	-		
AF20	NC	-		
AF23	NC	-		
AF5	NC	-		
AG23	NC	-		
AG26	NC	-		
D10	NC	-		
E10	NC	-		
E11	NC	-		
F10	NC	-		
F20	NC	-		
F23	NC	-		
F8	NC	-		
G10	NC	-		
G20	NC	-		
G21	NC	-		
G7	NC	-		
G8	NC	-		
G9	NC	-		
H19	NC	-		
H20	NC	-		
H21	NC	-		
H22	NC	-		
H6	NC	-		
H8	NC	-		
H9	NC	-		
J10	NC	-		
J20	NC	-		
J21	NC	-		
J9	NC	-		
K9	NC	-		
R9	NC	-		
U22	NC	-		
W9	NC	-		
N13	VCCPLL	-		
N18	VCCPLL	-		
V13	VCCPLL	-		

LatticeECP2 S-Series Devices, Lead-Free Packaging

Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6SE-5TN144C	90	1.2V	-5	Lead-Free TQFP	144	Com	6
LFE2-6SE-6TN144C	90	1.2V	-6	Lead-Free TQFP	144	Com	6
LFE2-6SE-7TN144C	90	1.2V	-7	Lead-Free TQFP	144	Com	6
LFE2-6SE-5FN256C	190	1.2V	-5	Lead-Free fpBGA	256	Com	6
LFE2-6SE-6FN256C	190	1.2V	-6	Lead-Free fpBGA	256	Com	6
LFE2-6SE-7FN256C	190	1.2V	-7	Lead-Free fpBGA	256	Com	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12SE-5TN144C	93	1.2V	-5	Lead-Free TQFP	144	Com	12
LFE2-12SE-6TN144C	93	1.2V	-6	Lead-Free TQFP	144	Com	12
LFE2-12SE-7TN144C	93	1.2V	-7	Lead-Free TQFP	144	Com	12
LFE2-12SE-5QN208C	131	1.2V	-5	Lead-Free PQFP	208	Com	12
LFE2-12SE-6QN208C	131	1.2V	-6	Lead-Free PQFP	208	Com	12
LFE2-12SE-7QN208C	131	1.2V	-7	Lead-Free PQFP	208	Com	12
LFE2-12SE-5FN256C	193	1.2V	-5	Lead-Free fpBGA	256	Com	12
LFE2-12SE-6FN256C	193	1.2V	-6	Lead-Free fpBGA	256	Com	12
LFE2-12SE-7FN256C	193	1.2V	-7	Lead-Free fpBGA	256	Com	12
LFE2-12SE-5FN484C	297	1.2V	-5	Lead-Free fpBGA	484	Com	12
LFE2-12SE-6FN484C	297	1.2V	-6	Lead-Free fpBGA	484	Com	12
LFE2-12SE-7FN484C	297	1.2V	-7	Lead-Free fpBGA	484	Com	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20SE-5QN208C	131	1.2V	-5	Lead-Free PQFP	208	Com	20
LFE2-20SE-6QN208C	131	1.2V	-6	Lead-Free PQFP	208	Com	20
LFE2-20SE-7QN208C	131	1.2V	-7	Lead-Free PQFP	208	Com	20
LFE2-20SE-5FN256C	193	1.2V	-5	Lead-Free fpBGA	256	Com	20
LFE2-20SE-6FN256C	193	1.2V	-6	Lead-Free fpBGA	256	Com	20
LFE2-20SE-7FN256C	193	1.2V	-7	Lead-Free fpBGA	256	Com	20
LFE2-20SE-5FN484C	331	1.2V	-5	Lead-Free fpBGA	484	Com	20
LFE2-20SE-6FN484C	331	1.2V	-6	Lead-Free fpBGA	484	Com	20
LFE2-20SE-7FN484C	331	1.2V	-7	Lead-Free fpBGA	484	Com	20
LFE2-20SE-5FN672C	402	1.2V	-5	Lead-Free fpBGA	672	Com	20
LFE2-20SE-6FN672C	402	1.2V	-6	Lead-Free fpBGA	672	Com	20
LFE2-20SE-7FN672C	402	1.2V	-7	Lead-Free fpBGA	672	Com	20

LatticeECP2M Part Number Description

LFE2M XXX XE – X XXXXXX X

Device Family
ECP2M (LatticeECP2 FPGA + SERDES)

Logic Capacity
20 = 20K LUTs
35 = 35K LUTs
50 = 50K LUTs
70 = 70K LUTs
100 = 100K LUTs

Encryption
S = Security Series (Encryption Feature)
Blank = Standard Series (No Encryption)

Supply Voltage
E = 1.2V

Grade
C = Commercial
I = Industrial

Package
F256 = 256-ball fpBGA
F484 = 484-ball fpBGA
F672 = 672-ball fpBGA
F900 = 900-ball fpBGA
F1152 = 1152-ball fpBGA

FN256 = 256-ball Lead-free fpBGA
FN484 = 484-ball Lead-free fpBGA
FN672 = 672-ball Lead-free fpBGA
FN900 = 900-ball Lead-free fpBGA
FN1152 = 1152-ball Lead-free fpBGA

Speed
5 = Slowest
6
7 = Fastest

Ordering Information

Note:þLatticeECP2M devices are dual marked. For example, the commercial speed grade LFE2M50E-7F672C is also marked with industrial grade -6I (LFE2M50E-6F672I). The commercial grade is one speed grade faster than the associated dual mark industrial grade. The slowest commercial grade does not have industrial markings. The markings appear as follows: